

Dual N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)			
30	$0.015 \text{ at V}_{GS} = 10 \text{ V}$	25	4.6 nC			
	$0.018 \text{ at V}_{GS} = 4.5 \text{ V}$	22	4.0110			

5678

FEATURES

- DT-Trench Power MOSFET
- 100 % UIS Tested
- 100 % R_g Tested

APPLICATIONS

Load Switch

Compliant to RoHS Directive 2002/95/EC

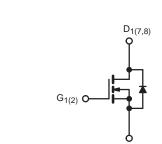
• Networking DC-DC Power System



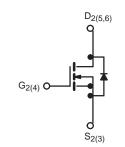
COMPLIANT

Top View **Bottom View**

PDFN 3.3x3.3







N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V_{GS}	± 20	V	
	T _C = 25 °C	- I _D	25 ^a		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C		21		
Continuous Diam Current (1) = 150 C)	T _A = 25 °C		20 ^{b, c}		
	T _A = 70 °C		17 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	75		
Continuous Source-Drain Diode Current	T _C = 25 °C	l-	25		
	T _A = 25 °C	- I _S	1.67 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	6		
Single Pulse Avalanche Energy		E _{AS}	16	mJ	
Maximum Power Dissipation	T _C = 25 °C		15		
	T _C = 70 °C	P _D	12	W	
	T _A = 25 °C] ''	13 ^{b, c}	VV	
	T _A = 70 °C		10 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{a, c, d}	t ≤ 10 s	R _{thJA}	58	70	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	38	45] 0///	

Notes:

- a. Package limited, T_C = 25 °C.
 b. Surface Mounted on 1" x 1" FR4 board.
- d. Maximum under Steady State conditions is 110 °C/W.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		22			
$V_{\rm GS(th)}$ Temperature Coefficient $\Delta V_{\rm GS(th)}$				- 5.0		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	1.0		2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current		V _{DS} = 24 V, V _{GS} = 0 V			1		
	IDSS	V _{DS} = 24 V, V _{GS} = 0 V, T _J = 55 °C			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	75			А	
Drain-Source On-State Resistance ^a		$V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$		0.015	0.020	Ω	
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 4 \text{ A}$		0.018	0.025		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 5 A		23		S	
Dynamic ^b							
Input Capacitance	C _{iss}	3		697			
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		102		pF	
Reverse Transfer Capacitance	C _{rss}			39			
Total Gate Charge	Q _g	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$		4.6	7	nC	
		20 7 00 7 2		2.7			
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5 \text{ A}$		1.5			
Gate-Drain Charge	Q _{gd}			1			
Gate Resistance	R _g	f = 1 MHz		2.3	3.2	Ω	
Turn-On Delay Time	t _{d(on)}			18			
Rise Time	t _r	V_{DD} = 15 V, R_L = 3 Ω		10		-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		19			
Fall Time	t _f			8			
Turn-On Delay Time	t _{d(on)}			14		ns	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 3 \Omega$		9		-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		16			
Fall Time	t _f	-		6			
Drain-Source Body Diode Characteristic	cs						
Continuous Source-Drain Diode Current	Is	T _C = 25 °C			25	^	
Pulse Diode Forward Current	I _{SM}				75	A	
Body Diode Voltage	V _{SD}	I _S = 2 A, V _{GS} = 0 V		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			11		ns	
Body Diode Reverse Recovery Charge	Q _{rr}	L EA di/dt 400 A/: T 05 00		4		nC	
Reverse Recovery Fall Time	t _a	$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		7		ns	
Reverse Recovery Rise Time	t _b			4			

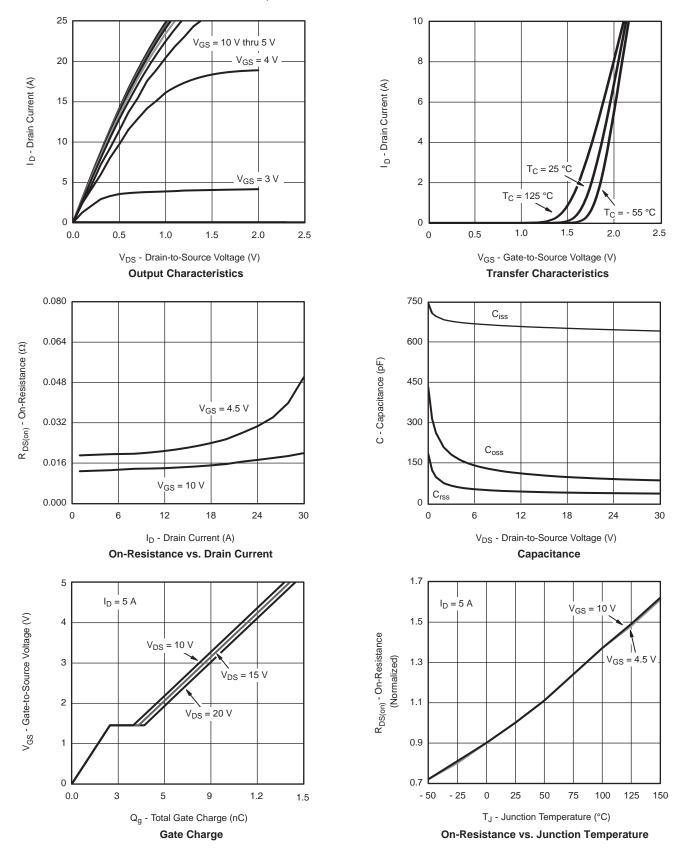
Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$

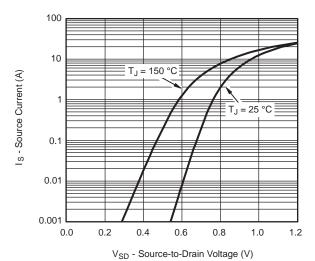
b. Guaranteed by design, not subject to production testing.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

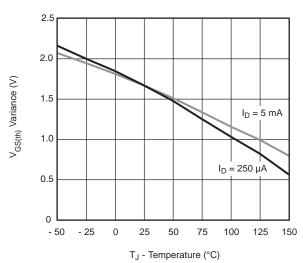




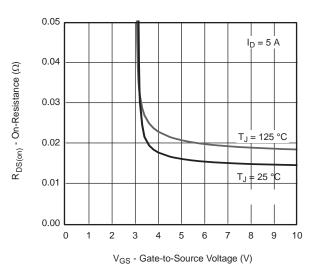
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



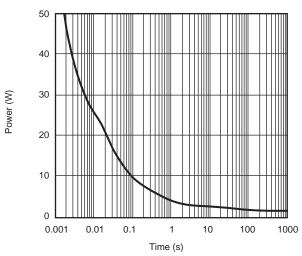
Source-Drain Diode Forward Voltage



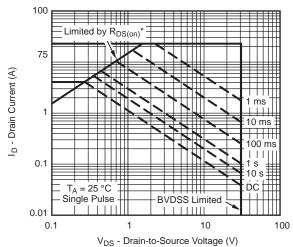
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



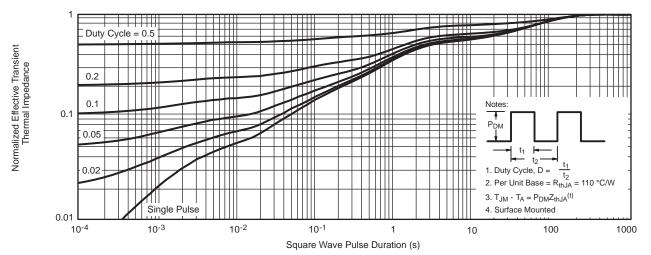
Single Pulse Power



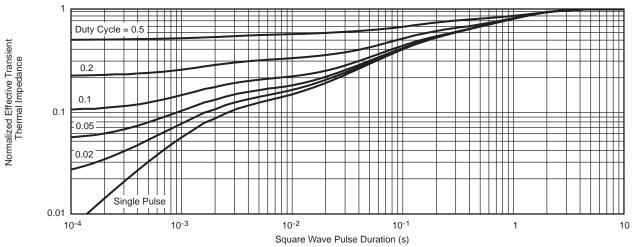
* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

Safe Operating Area, Junction-to-Ambient

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot





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